

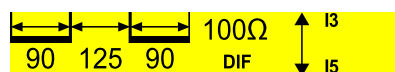
Material (µm)	Stack up	File	Assembly
25 Galvanic Cu			A1
17 Copper			
75 NP-155F-B			
65 NP-155F-B	R: 64	1080	
17 Copper			
200 NP-155F-TL			
17 Copper			
65 NP-155F-B	R: 64	1080	
65 NP-155F-B	R: 64	1080	
17 Copper			
200 NP-155F-TL			
17 Copper			
65 NP-155F-B	R: 64	1080	
65 NP-155F-B	R: 64	1080	
17 Copper			
200 NP-155F-TL			A1
17 Copper			
65 NP-155F-B	R: 64	1080	
65 NP-155F-B	R: 64	1080	
17 Copper			
200 NP-155F-TL			
17 Copper			
65 NP-155F-B	R: 64	1080	
65 NP-155F-B	R: 64	1080	
17 Copper			
200 NP-155F-TL			
17 Copper			
65 NP-155F-B	R: 64	1080	
65 NP-155F-B	R: 64	1080	
17 Copper			
200 NP-155F-TL			A1
17 Copper			
65 NP-155F-B	R: 64	1080	
65 NP-155F-B	R: 64	1080	
17 Copper			
200 NP-155F-TL			
17 Copper			
65 NP-155F-B	R: 64	1080	
65 NP-155F-B	R: 64	1080	
17 Copper			
200 NP-155F-TL			
17 Copper			
65 NP-155F-B	R: 64	1080	
65 NP-155F-B	R: 64	1080	
17 Copper			
200 NP-155F-TL			A1
17 Copper			
65 NP-155F-B	R: 64	1080	
75 NP-155F-B			
17 Copper	R: 64	1080	
25 Galvanic Cu			

Thickness

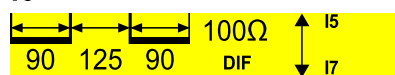
Bare Board	2.13 mm - 2.60 mm
Immersion Tin	2.13 mm - 2.61 mm
Hot-Air	2.15 mm - 2.62 mm
Immersion Gold	2.14 mm - 2.61 mm

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Generated by gbiernat

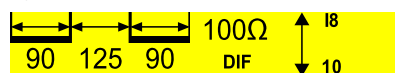
i4



i6



i9



11

